

后芮驷(上海)电子有限公司

Horus International Electronics Co., LTD.



SPECIFICATION FOR APPROVAL

编号:

品名	DESCRIPTION:	SMD Type Power
规格	SPEC :	HRS-RCA-C1040-100M
包装	PACKAGE:	卷装
客户	CUSTOMER:	

客户料号 CUSTOMER P/N:

APPROVED BY		
	王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王王	
CUSTOMER	HORUS	





SMD Type Power

Inductor P/N:

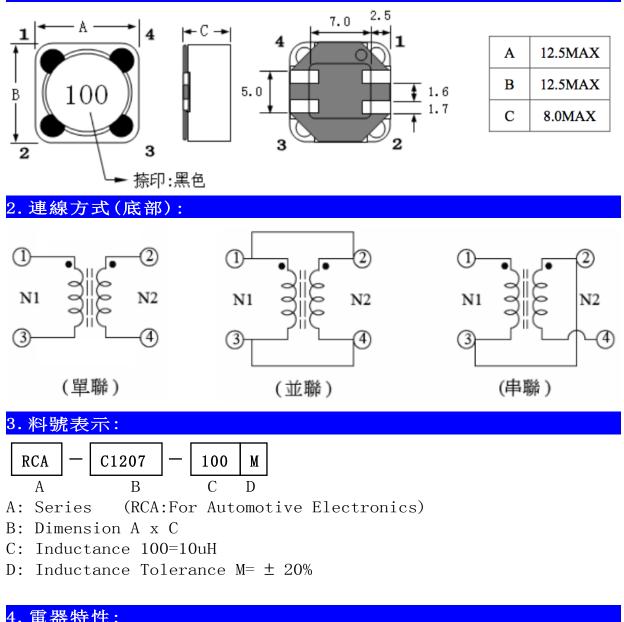


Moisture Sensitivity Level: 1

*Content in this sheet are subject to change without prior notice



1.形狀尺寸(單位:mm)



4. 電器符性:				
Part Number	Inductance(uH)@ 0.25V/100KHz	Isat(A) Typ.	Irms(A) Max.	DCR(mΩ) Max.
RCA-C1207-100M	10	8.0	3	44

Note: 測試儀器(Test instruments): L:3302+1320;DCR:Zentech502BC;尺寸:Calipers



5. 信賴性測試標準

Item	Performance	Test Condition		
Operating temperature	-40~+125 $^{\circ}$ C (Including self - temperature rise)			
Storage temperature and Humidity range	110~+40°C ,50~60%RH (Product with taping) 240~+125°C (on board)			
Electrical Performance	Test			
Inductance	Refer to standard electrical characteristics	HP4284A, CH11025, CH3302, CH1320, CH1320S LCR Meter.		
DCR	list.	CH16502,Agilent33420A Micro-Ohm Meter.		
Saturation Current (Isat)	Approximately △L30%	Saturation DC Current (Isat) will cause L0 to drop $\triangle L(\%)$		
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise $\Delta T(C)$. 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer		
Reliability Test				
High Temperature Exposure (Storage) AEC-Q200		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles Temperature : 180±2°C (Inductor) Duration : 1000hrs Min. Measured at room temperature after placing for 24±2 hrs.		
Temperature Cycling AEC-Q200		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1 : $-40\pm^2$ °C 30min Min.(Inductor) Step2 : $125\pm^2$ °C transition time 1 min MAX. Step3 : $125\pm^2$ °C 30min Min. Step4 : Low temp. Transition time 1 min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24±2 hrs.		
Moisture Resistance		Preconditioning:Run through IR reflow for 2 times.(IPC/JEDEC) J-STD-020DClassification Reflow Profiles 1.Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, early the second temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, the second temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, keep at 25°C for 2.5hrs then keep at -10°C for 3hrs 4.Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.		
Biased Humidity (AEC-Q200)		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity : 85±3% R.H, Temperature : 85°C±2°C Duration: 1000hrs Min with 100% rated current. Measured at room temperature after placing for24±2hrs		
High Temperature Operational Life (AEC-Q200)		Preconditioning: Run through IR reflow for 2 times, (IPC/JEDEC J-STD-020DClassification Reflow Profiles Temperature : 180±2°C (Inductor) Duration : 1000hrs Min. With 100% rated current. Measured at room temperature after placing for24±2hrs		
External Visual	Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.		
Physical Dimension	According to the product specification size measurement	ment According to the product specification size measurement		
Resistance to Solvents	Appearance : No damage.	Add aqueous wash chemical - OKEM clean or equivalent.		
Mechanical Shock	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value.	Type Peak value (g's) Normal Duration (D) (ms) Wave form Velocity Change (Vi)ft/sec SMD 100 6 Half-sine 12.3		
	RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Lead 100 6 Half-sine 12.3 Shocks in each direction along 3 perpendicular axes.		



Item	Performance	Test Condition		
Vibration		IPC/JEDEC J-STD-020DClassification Reflow Profiles Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minute Equipment : Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) ∘		
Resistance to Soldering Heat	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value	Test condition : Temperature () Time(s) Temperature ramp/immersion And emersion rate 260±5(solder 40)4 25mm/s (emm/s 14)		
	Q : Shall not exceed the specification value. RDC : within \pm 15% of initial value and shall not exceed the specification value	temp) 10±1 2011/1/8 ±0 1111/8 ±0 1111/8 Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC		
Thermal shock (AEC-Q200)		J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1 : -40±2℃ 15±1min(Inductor) Step2 : 125±2℃ within 20Sec. Step3 : 125±2℃ 15±1min Number of cycles : 300 Measured at room temperature after placing fo24±2hrs		
ESD	Appearance:No damage.	10 to		
Solder ability	More than 95% of the terminal electrode should be covered with solder \circ	Steam Aging: 8 hours ± 15 min Preheat: 150 , 60sec. Solder: Sn96.5% Ag3% Cu0. 5% Temperature: 245±5		
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation.		
Flammability	Electrical Test not required.	V-0 or V-1 are acceptable.		
Board Flex	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board.		
		Radius 340 Printed circuit board under test		
Terminal Strength (SMD)	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020D Classification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. radius 0,5 mm DUT under thickness substrate press tool shear force		



6. 貼片迴焊溫度

(1) Soldering

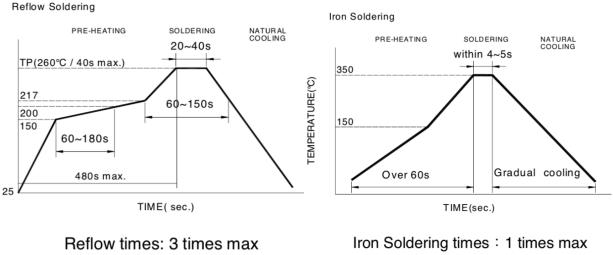
Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. The terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools. Note. If Use Wave soldering is there will be some risk. Re-flow soldering temperatures below 240 degrees, there will be unwitting risk

(2) Solder re-flow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1.

(3) Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. for Iron Soldering in Figure 2.





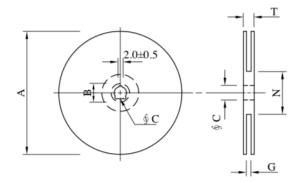
Iron Soldering times : 1 times max Fig.2

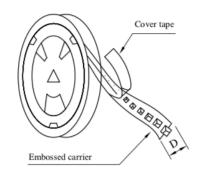


7. 包裝方式:

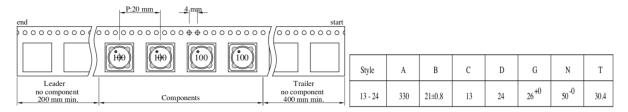
Packaging Quantity: 400pcs/Reel

Reel Dimension:

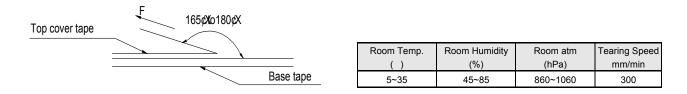




*Carrier tape width : D



Tearing Off Force:



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-D-2008 of 4.11 standard).

Application Notice

Storage Conditions To maintain the solder ability of terminal electrodes:

1. RDM products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.

- 2. Temperature and humidity conditions: -10~ 40 $^{\circ}\mathrm{C}$ and 30~70% RH.
- 3. Recommended products should be used within 6 months from the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- · Transportation1.Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

Modify records:				
Version	Page	Description		
V01	N/A	New issued		